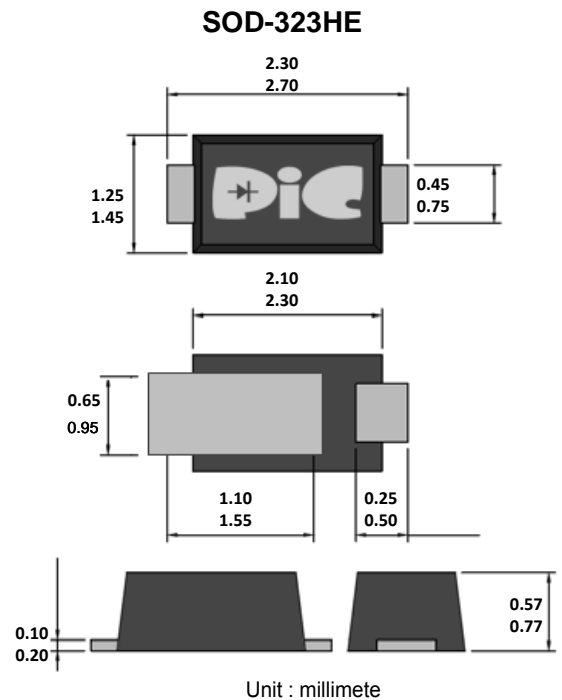


Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Mechanical Data

- Case: SOD-323HE
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 5.4mg/0.00019oz



Absolute Maximum Ratings and Electrical characteristics

Parameter	Symbols	SS1040LHSW	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	40	V
Maximum RMS voltage	V_{RMS}	28	V
Maximum DC Blocking Voltage	V_{DC}	40	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1.0	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	25	A
Max Instantaneous Forward Voltage at 1 A	V_F	0.47	V
Maximum DC Reverse Current at Rated DC Reverse Voltage	I_R	0.5 20	mA
Typical Junction Capacitance ⁽¹⁾	C_j	160	pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	150	°C/W
Operating Junction Temperature Range	T_j	-55 ~ +125	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 8X 8 mm copper pad areas.

Rating and Characteristics Curves

Fig.1 Forward Current Derating Curve

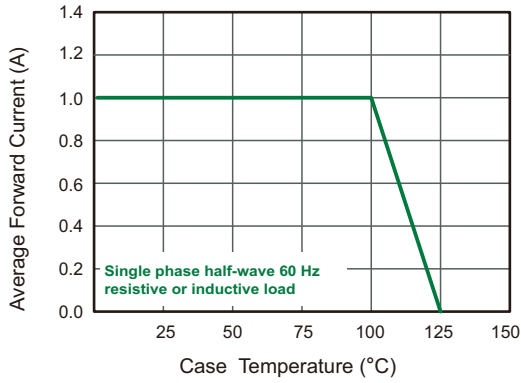


Fig.2 Typical Reverse Characteristics

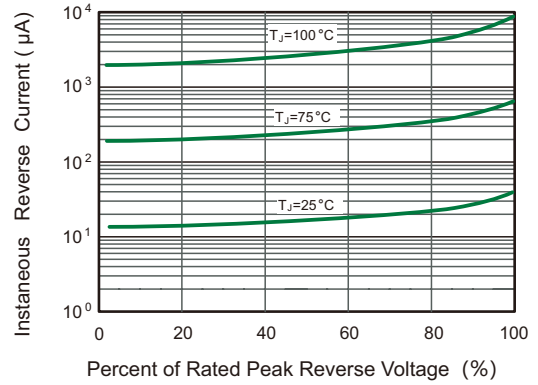


Fig.3 Typical Forward Characteristic

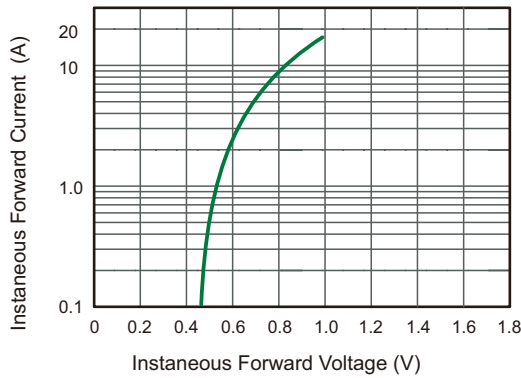


Fig.4 Typical Junction Capacitance

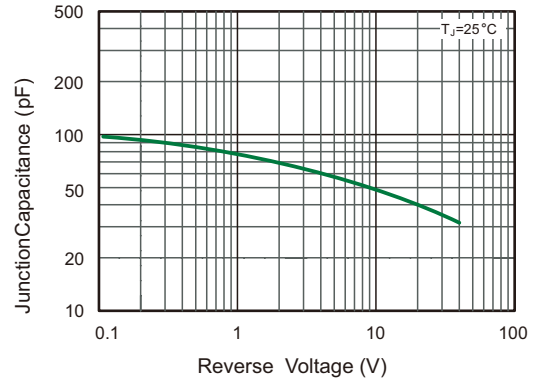


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

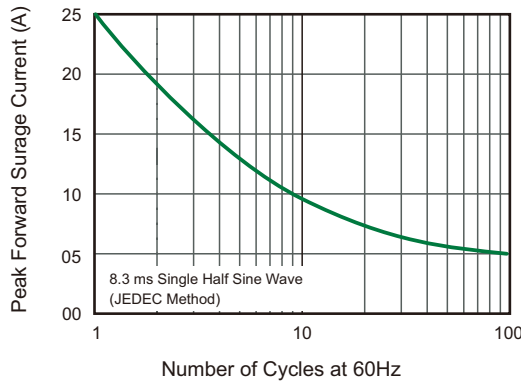
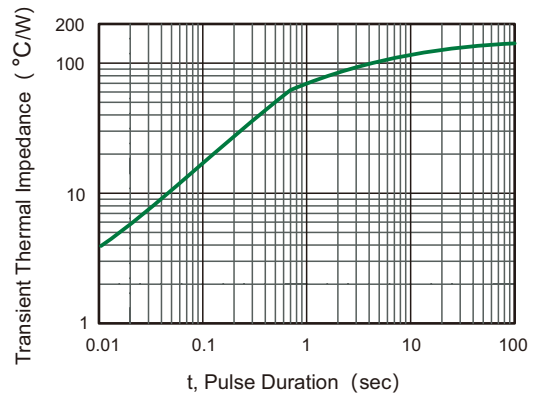
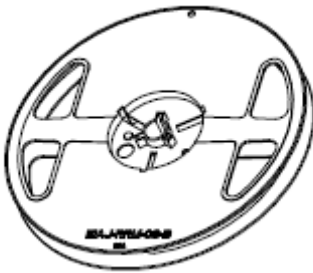
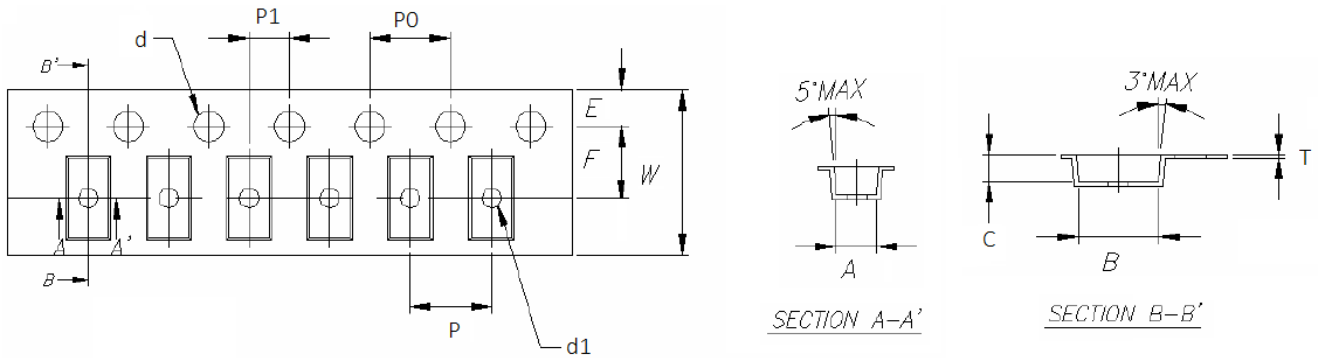


Fig.6 Typical Transient Thermal Impedance

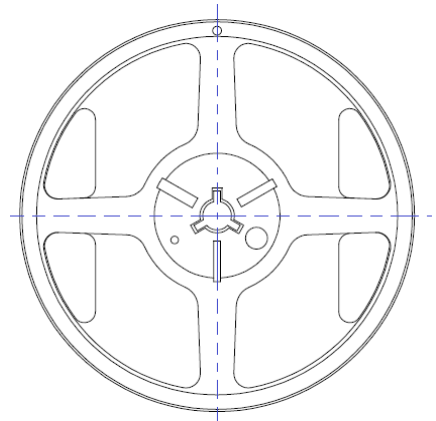
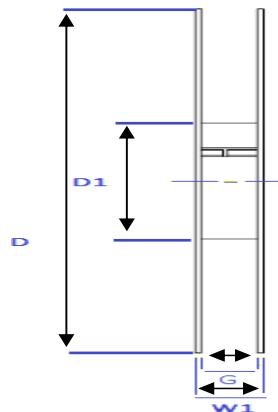
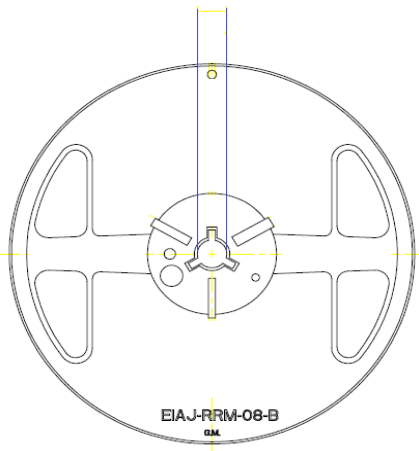


Packaging Specifications

Package	W (mm)	A (mm)	B (mm)	C (mm)	d1 (mm)	d (mm)	E (mm)	F (mm)	P (mm)	P0 (mm)	P1 (mm)	T (mm)
SOD-123FL	8±0.2	2.00±0.1	3.85±0.1	1.1±0.1	1.0	1.50±0.1	1.75±0.1	3.5±0.05	4±0.1	4±0.05	2±0.05	0.23±0.05
SOD-123HE	8±0.3	2.00±0.1	4.00±0.1	1.45±0.1	1.0	1.55±0.1	1.75±0.1	3.5±0.05	4±0.1	4±0.10	2±0.05	0.23±0.10
SOD-323FL	8±0.2	1.37±0.1	2.75±0.1	0.85±0.1	1.00	1.60±0.1	1.75±0.1	3.50±0.05	4±0.1	4±0.10	-	0.20±0.10
SOD-323HE	8±0.3	1.60±0.1	2.80±0.1	0.95±0.1	1.0	1.50±0.1	1.75±0.1	3.5±0.05	4±0.1	4±0.10	2±0.05	0.23±0.10
SMAF	12±0.3	2.9±0.1	5.5±0.1	2.1±0.1	1.5	1.55±0.1	1.75±0.1	5.5±0.05	4±0.1	4±0.10	2±0.05	0.23±0.10
SMA-S	12±0.2	2.65±0.1	5.25±0.1	1.35±0.1	1.0	1.55±0.1	1.75±0.1	5.5±0.05	4±0.1	4±0.05	2±0.05	0.23±0.10
SMA-HE	12±0.2	2.65±0.1	5.25±0.1	1.35±0.1	1.0	1.55±0.1	1.75±0.1	5.5±0.05	4±0.1	4±0.05	2±0.05	0.23±0.10

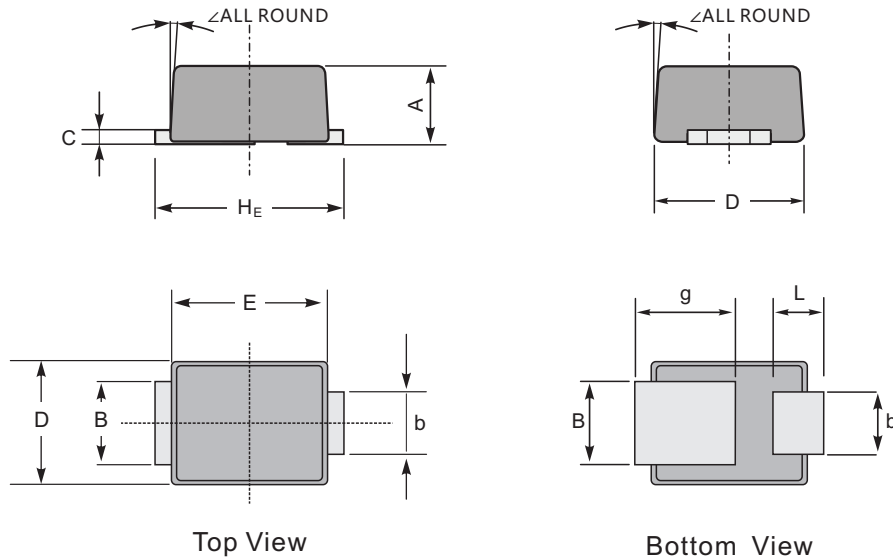


Package	D (max.) (mm)	D1 (min.) (mm)	D2 (mm)	G (min.) (mm)	W1 (min.) (mm)
SOD-123FL	178	50.0	13.0±0.2	8.4	11.4
SOD-123HE	178	50.0	13.0±0.2	8.4	11.4
SOD-323FL	178	50.2	13.0±0.2	8.0	11.5
SOD-323HE	178	50.0	13.0±0.2	8.4	11.4
SMAF	178	50.0	13.0±0.2	12.4	18.0
	330	50.0	13.0±0.2	12.4	18.0
SMA-S	178	50.0	13.0±0.2	12.4	18.0
SMA-HE	178	50.0	13.0±0.2	12.4	18.0



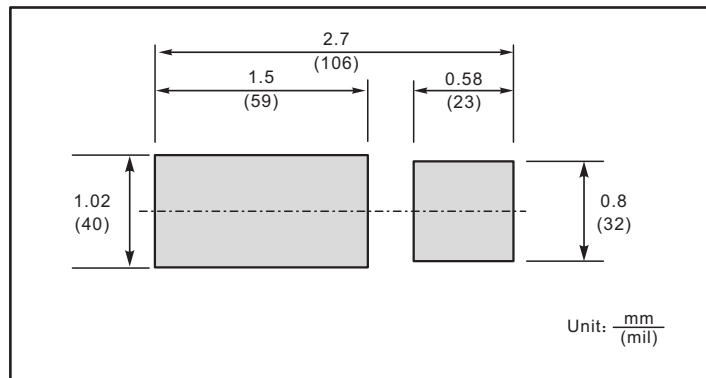
PACKAGE OUTLINE SOD-323HE

Plastic surface mounted package; 2 leads



UNIT		A	b	B	C	D	E	H _E	g	L	\angle
mm	max	0.77	0.75	0.95	0.20	1.45	2.3	2.7	1.55	0.50	12°
	min	0.57	0.45	0.65	0.10	1.25	2.1	2.3	1.1	0.25	
mil	max	30	30	37	8	57	91	106	61	20	
	min	22	18	26	4	49	83	91	43	10	

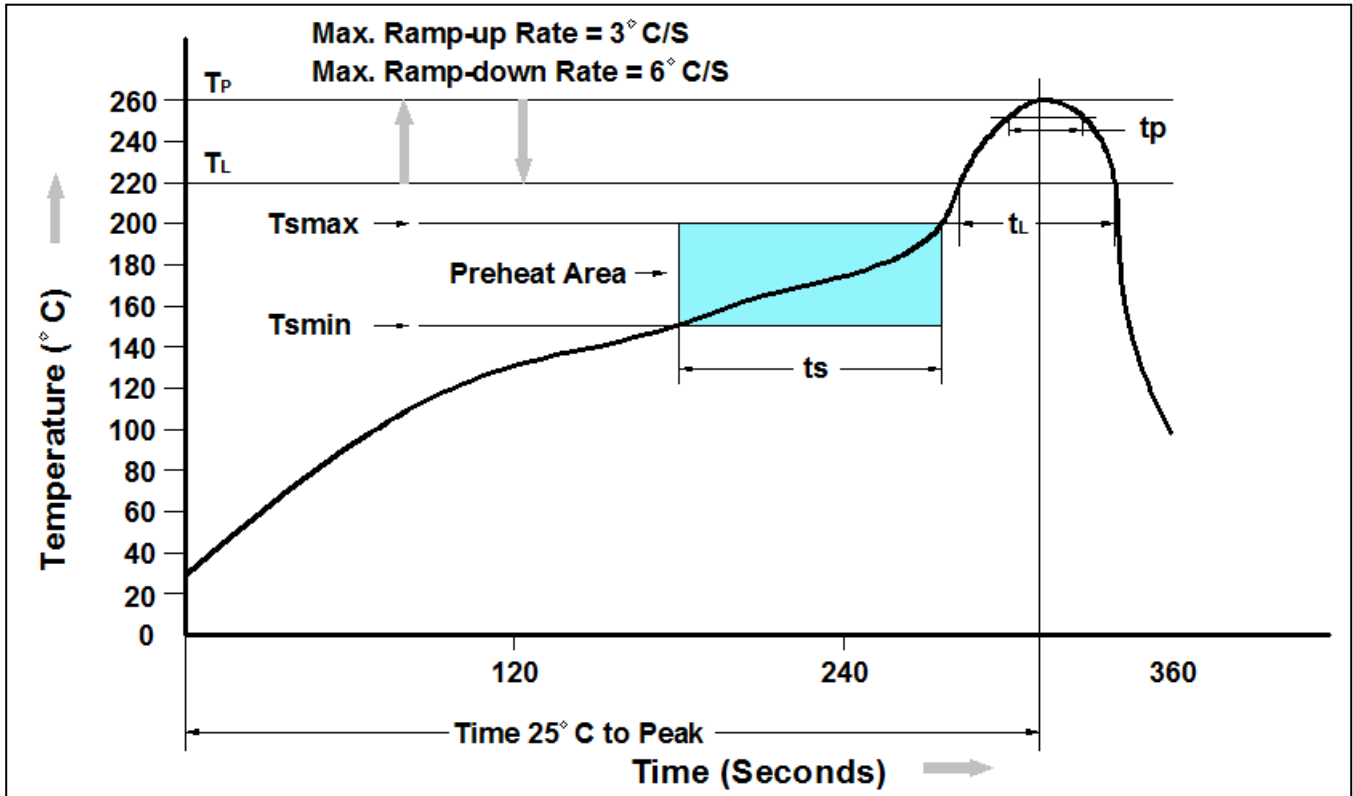
The recommended mounting pad size



Ordering Information

Part Number	Description	Quantity
SS1040LHSW	SOD-323HE Reel	3,000 pcs

Recommend IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T Amin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (T Amin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

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